

#### SURFACE MOUNT SCHOTTKY BARRIER DIODE ARRAY

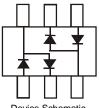
### **Features**

- Low Forward Voltage Drop
- **Guard Ring Construction for Transient Protection**
- Fast Switching
- Low Reverse Capacitance
- Lead Free/RoHS Compliant (Note 3)
- "Green" Device, (Note 4 and 5)



## **Mechanical Data**

- Case: SOT-26
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Polarity: See Diagram
- Leads: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Copper leadframe).
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.016 grams (approximate)



Device Schematic

### **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	28	V
Forward Continuous Current (Note 1)	I <sub>FM</sub>	350	mA
Non-Repetitive Peak Forward Surge Current @ t ≤ 1.0	s I <sub>FSM</sub>	1.5	Α

#### Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	$P_{D}$	225	mW
Thermal Resistance, Junction to Ambient Air (Note 1)	$R_{\theta JA}$	444	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +125	°C

### **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

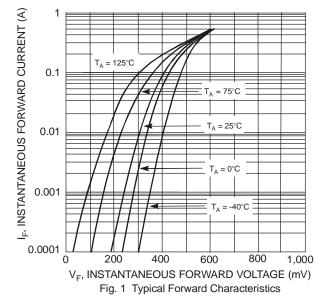
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	$V_{(BR)R}$	40	_	_	V	$I_R = 100 \mu A$
Forward Voltage Drop	V <sub>F</sub>		_	0.37 0.50 0.60	V	I <sub>F</sub> = 20mA I <sub>F</sub> = 100mA I <sub>F</sub> = 200mA
Reverse Current (Note 2)	I <sub>R</sub>	_	_	5.0	μΑ	$V_R = 30V$
Total Capacitance	C <sub>T</sub>	_	50	_	pF	$V_R = 0V, f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>	_	10	_	ns	$I_F = I_R = 200 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

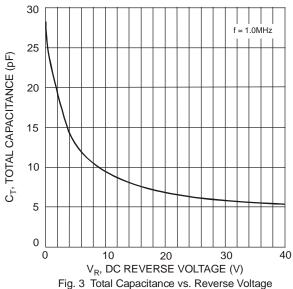
- Notes: 1. Device mounted on FR-5 PCB 1.0 x 0.75 x 0.062 inch pad layout as shown on Diodes Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
  - Short duration pulse test used to minimize self-heating effect.
  - 3. No purposefully added lead.

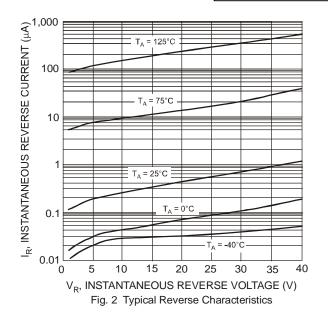
  - Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.

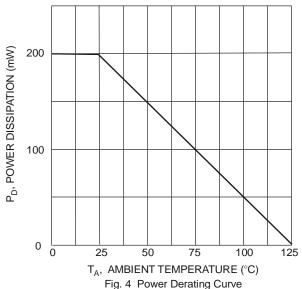
    Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.









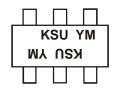


# Ordering Information (Notes 5 & 6)

ĺ	Part Number	Case	Packaging
	SD103ASDM-7-F	SOT-26	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## **Marking Information**



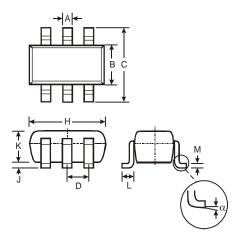
KSU = Product Type Marking Code YM = Date Code Marking Y = Year (ex: T = 2006) M = Month (ex: 9 = September)

Date Code Key

Date Coc	Citcy													
Year	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
Code	N	Р	R	S	T	U	V	W	X	Υ	Z	Α	В	С
Month	Jan	Feb	Ma	ar .	Apr	May	Jun	Jul	Aug	Se	p (	Oct	Nov	Dec
Code	1	2	3	3	4	5	6	7	8	9		0	N	D

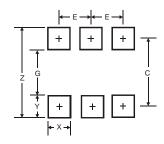


## **Package Outline Dimensions**



	SOT-26					
Dim	Min	Max	Тур			
Α	0.35	0.50	0.38			
В	1.50	1.70	1.60			
С	2.70	3.00	2.80			
D	<b>D</b> — 0.95					
Н	2.90	3.10	3.00			
J	0.05					
<b>K</b> 1.00 1.30 1.10						
L	<b>L</b> 0.35 0.55 0.40					
M	<b>M</b> 0.10 0.20 0.15					
α	0°	8°				
All Dimensions in mm						

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	3.20
G	1.60
X	0.55
Y	0.80
С	2.40
E	0.95

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